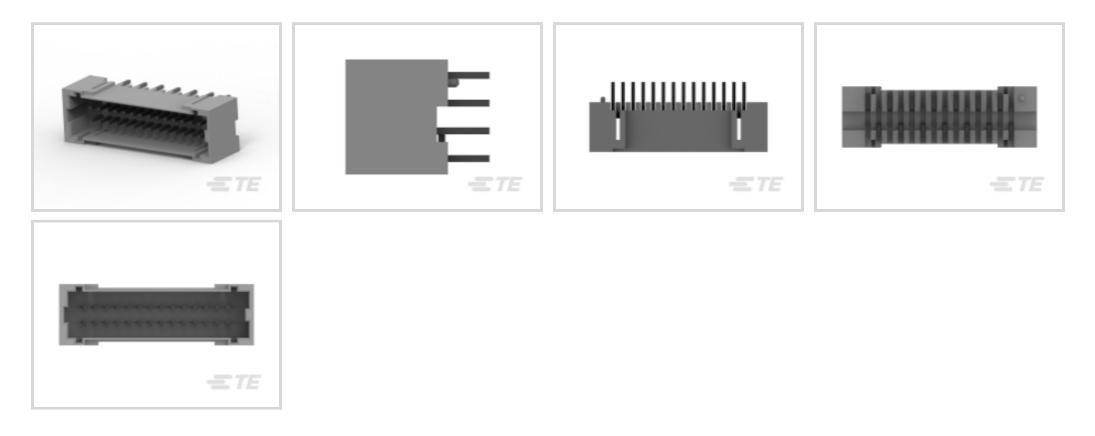
2-292208-8 - ACTIVE

AMP Mini CT

TE Internal #: 2-292208-8 PCB Mount Header, Vertical, Wire-to-Board, 28 Position, 1.5 mm [. 059 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMP Mini CT

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 28

Number of Rows: 2

Centerline (Pitch): 1.5 mm [.059 in]

PCB Mount Orientation: Vertical

Features

connectivity

Product Type Features

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	28
Number of Rows	2
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	50 VAC
Body Features	
Primary Product Color	Gray

PCB Mount Header, Vertical, Wire-to-Board, 28 Position, 1.5 mm [.059 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMP Mini CT



Contact Features

Contact Mating Area Length	2.4 mm[.095 in]
Mating Square Post Dimension	.5 mm[.02 in]
PCB Contact Termination Area Plating Material Thickness	1 μm[39.37 μin]
Contact Layout	Staggered
Contact Mating Area Plating Material Thickness	1 μm[39.37 μin]
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Matte
PCB Contact Termination Area Plating Material	Pre-Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	2 A

Termination Features

Square Termination Post & Tail Dimension	.5 mm[.02 in]
Termination Post & Tail Length	3 mm[.118 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

Mechanical Attachment

PCB Mount Alignment Type	Locating Posts
Mating Alignment Type	Polarization
Mating Retention	With
PCB Mount Retention Type	Kinked Legs
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	With
PCB Mount Retention	With
Housing Features	
Housing Material	Nylon (G.F)
Centerline (Pitch)	1.5 mm[.059 in]
Dimensions	
Connector Length	26.5 mm[1.043 in]
Connector Height	7.4 mm[.291 in]

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PCB Mount Header, Vertical, Wire-to-Board, 28 Position, 1.5 mm [.059 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMP Mini CT



Connector Width	8.3 mm[.326 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
Row-to-Row Spacing	2 mm[.079 in]
Usage Conditions	
Operating Temperature Range	-22 – 221 °C[-30 – 105 °F]
Operation/Application	
Assembly Process Feature	Pick and Place Cover
Circuit Application	Signal
Industry Standards	
Agency/Standard	CSA, UL
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	850
Packaging Type	Box, Tray

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous

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materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

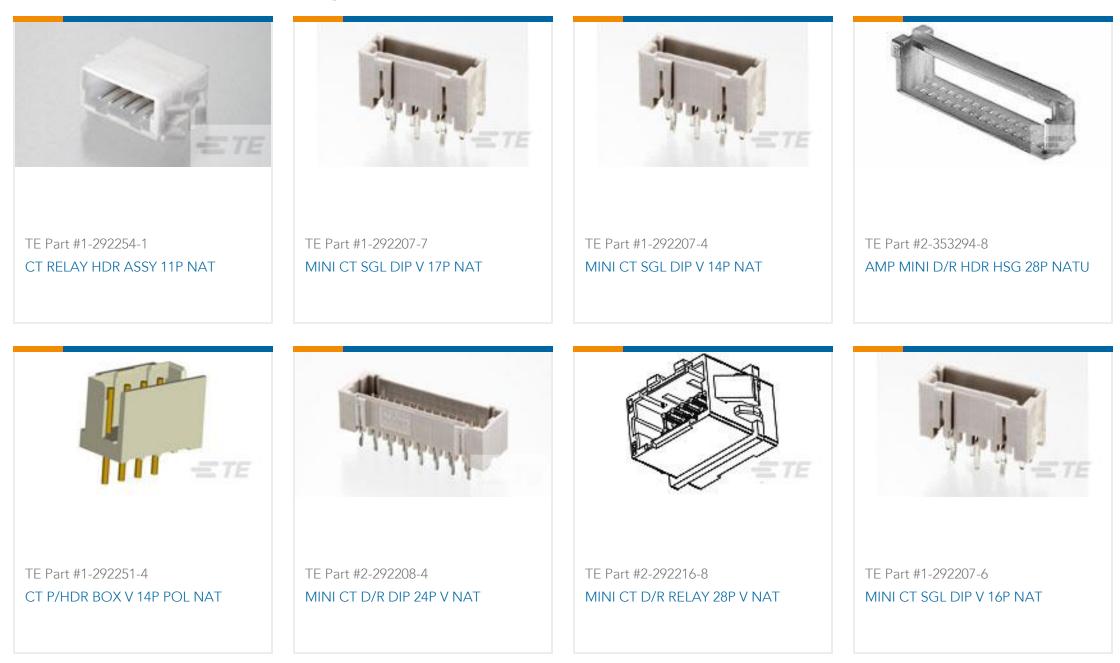
Compatible Parts



Also in the Series | AMP Mini CT



Customers Also Bought



Documents

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Product Drawings MINI CT D/R DIP 28P V NAT English **CAD** Files 3D PDF 3D **Customer View Model** ENG_CVM_CVM_2-292208-8_E.2d_dxf.zip English Customer View Model ENG_CVM_CVM_2-292208-8_E.3d_igs.zip English **Customer View Model** ENG_CVM_CVM_2-292208-8_E.3d_stp.zip English 3D PDF English **Customer View Model** ENG_CVM_2-292208-8_O.3d_igs.zip English **Customer View Model** ENG_CVM_2-292208-8_O.3d_stp.zip

English

Customer View Model

ENG_CVM_2-292208-8_O.2d_dxf.zip

English

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Product Specifications Application Specification

English

Product Environmental Compliance MD_2-292208-8_070420181012_dmtec

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Agency Approvals

UL

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